

Bending and assembly of the L0 and L1 layers

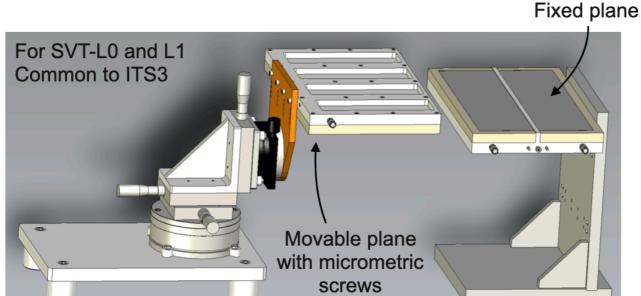
SVT Bari team
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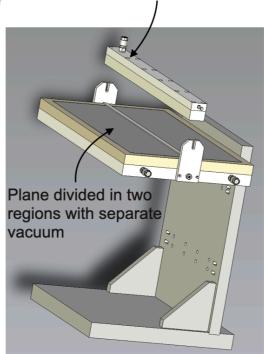


- 1. New sensor handling tools and support structure gluing tools
- 2. SVT-L0 half-layer attempt n. 3

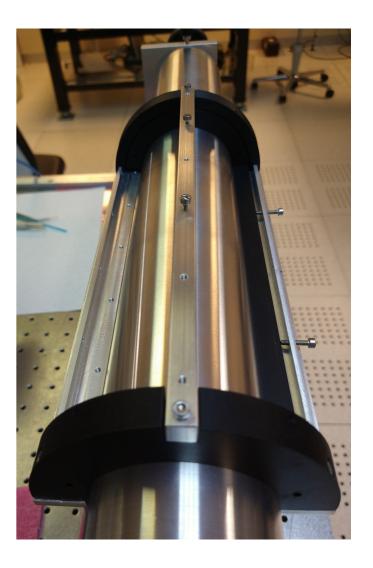


New sensor handling tools and support structure gluing tools





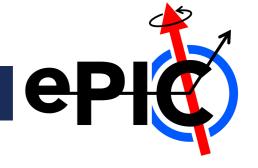
Adhesive tape vacuum handling tool.

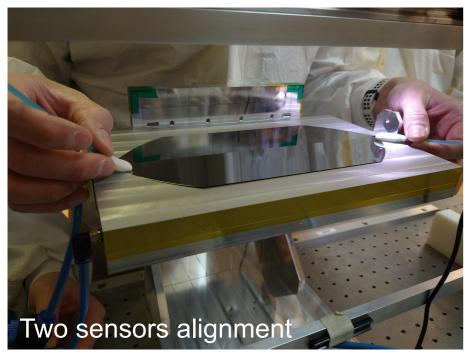


Required to:

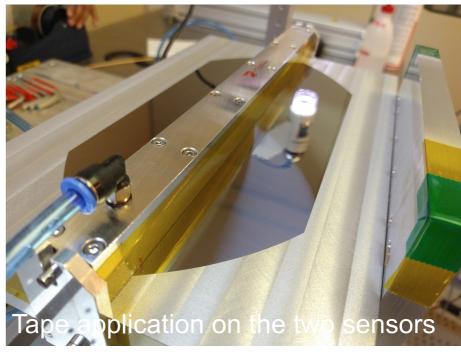
- Precisely align and join the two sensors
- Handle the joint sensors during the bending procedure to approach the mandrel
- New tool for support structures gluing

SVT-L0 half-layer attempt n. 3

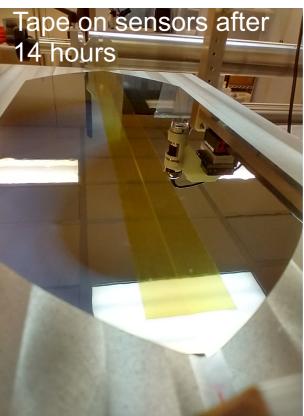




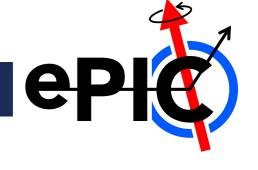


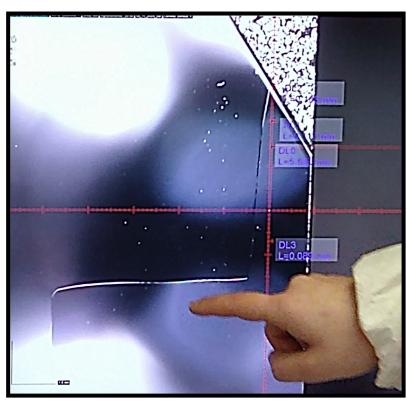






SVT-L0 half-layer attempt n. 3



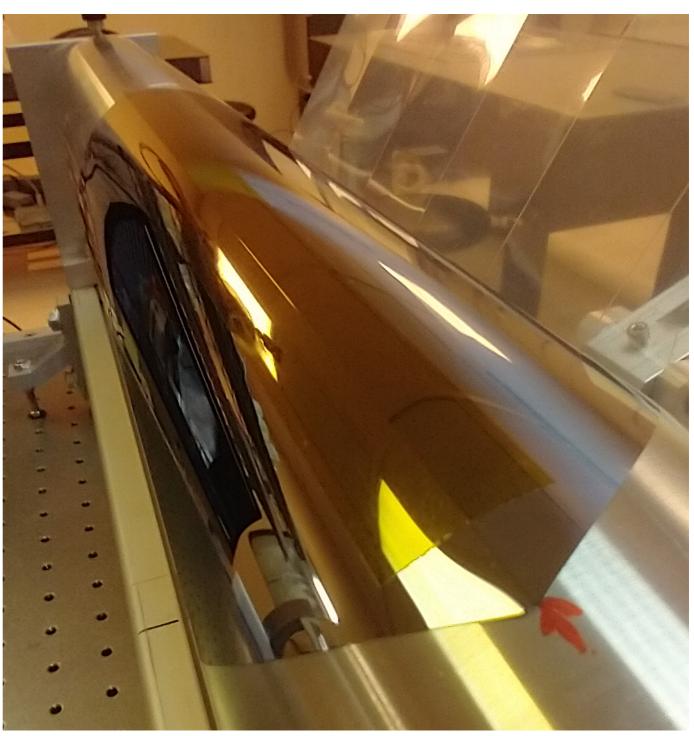


Crack stopped during bending procedures using microscope (not easily visible by eye).



Broken silicon pipe found in the same box

- Don't stack many silicons in the same box
- Visual inspection before each assembly

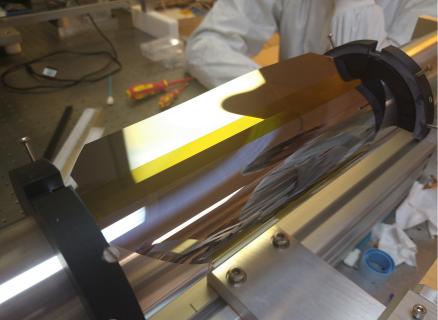


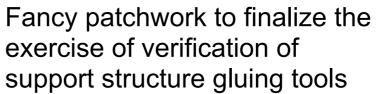
SVT-L0 half-layer attempt n. 3

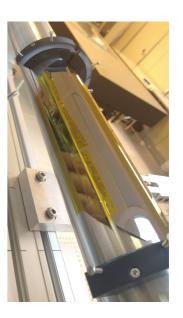




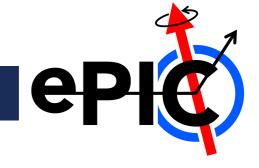


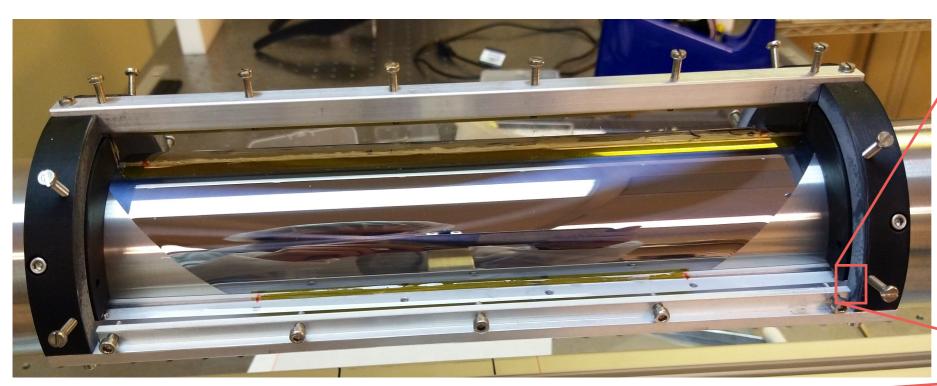


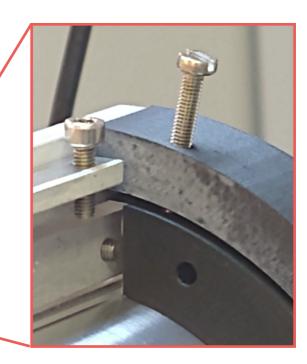


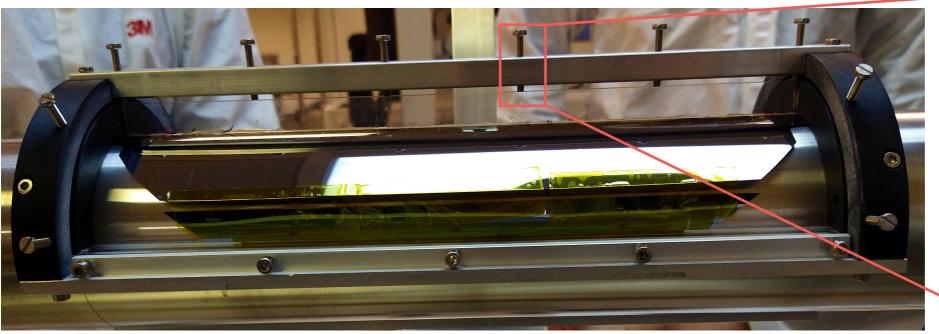


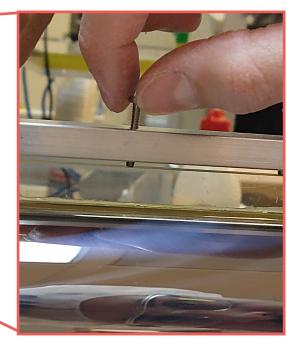
Recent progresses
SVT-L0 half-layer attempt n. 3



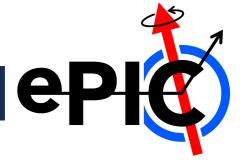






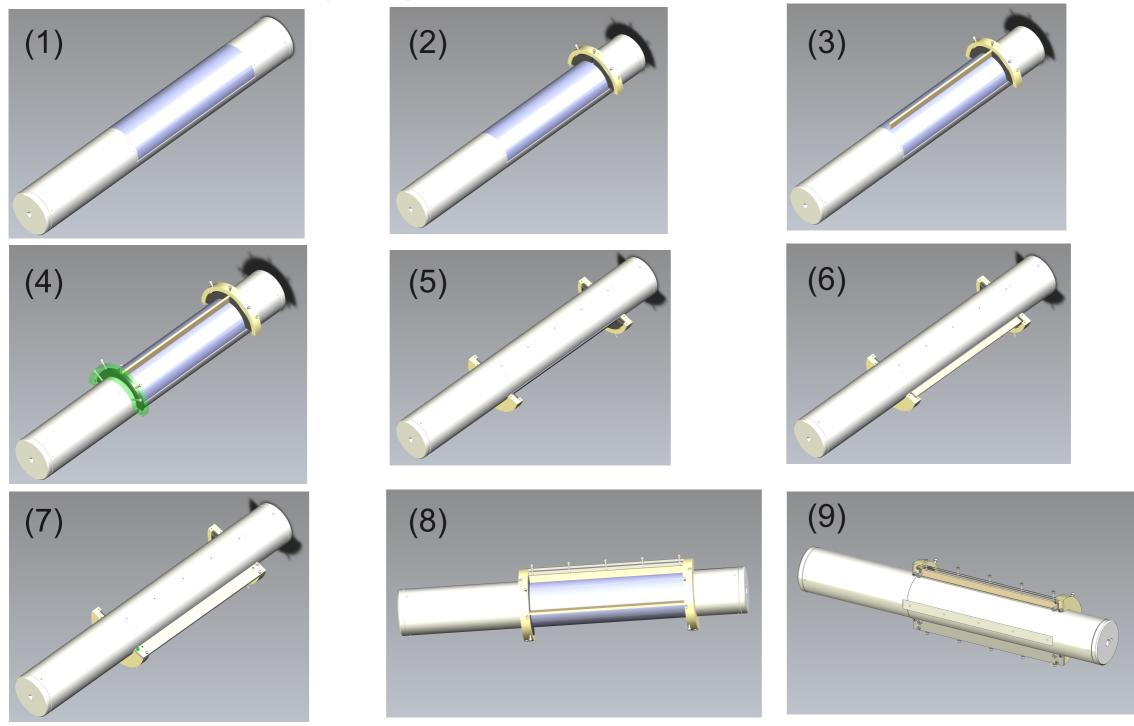


BACKUP



ePi

Support structures gluing tool

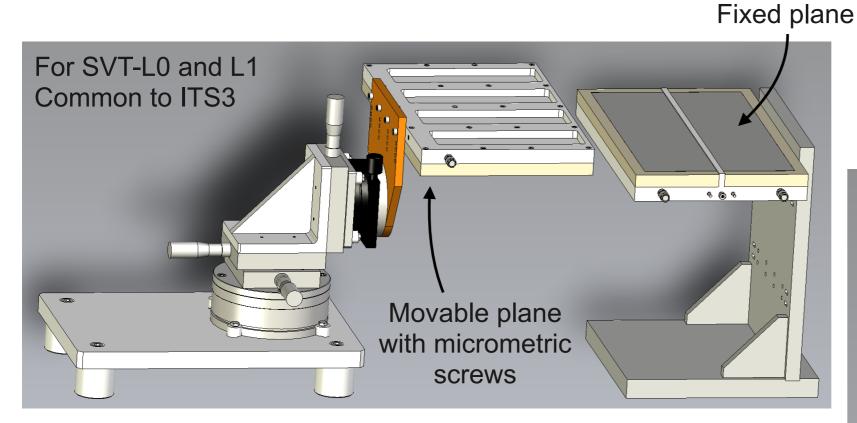


Tools under refinement after successful gluing.

Mainly improving pressing components for longerons to the sensors.

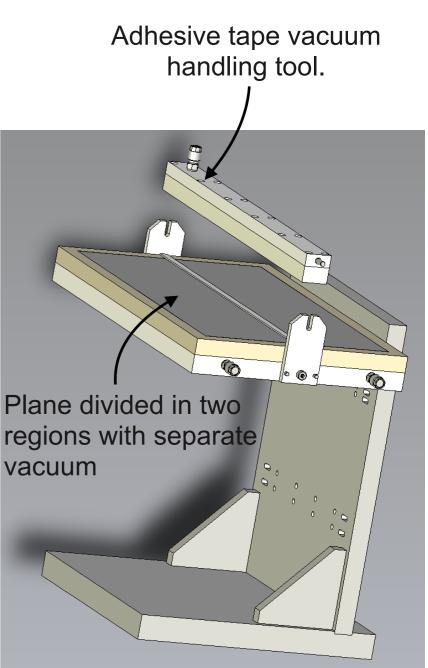
ePIC)

Sensors alignment and handling tools



Required to:

- Precisely align and join the two sensors
- Handle the joint sensors during the bending procedure to approach the mandrel



Prototyping campaign vs Material procurement



	Prototype	Components	Goal		_	
MAR 2025	IBL01_P1 (half-layer)	 2 naked silicon L1 sensors L1 local support structure (3-D printed) outer support shell (machined in PEEK) 	finalize half-layer assembly procedu	They require dummy silicon sensors from DISCO; to validate 2-sensor connection and	L	L0/L1 Silicon pieces
	IBL01_P2 (half-barrel)	 IBL01_P1 + 2 naked silicon L0 sensors L0 local support structure (3-D printed) 	finalize half-barrel assembly procedu	bending, to design local support structure, external shell etc		SS 3D printed
2025	IBL01_P3 (half-layer)	 2 naked silicon L1 sensors L1 local support structure (carbon foam) outer support shell (carbon fiber, to be defined) 	thermal chamber to	require:	equire:	L0/L1 Silicon pieces
JUL 2	IBL01_P4 (half-barrel)	IBL01_P3 +2 naked silicon L0 sensorsL0 local support structure (carbon foam)	thermal chamber to	est (procurement and machining TBD)		SS carbon fibre/foam
OCT 2025	IBL01_P5 (half-barrel)	 2+2 silicon L0+L1 sensors with heaters from CERN L0+L1 local support structures (carbon foam) outer support shell (carbon fiber, to be defined) 		(if yes, needs for design&simulation, procurement and machining)]	L0/L1 heaters
		air distribution inlet et outlet (to be designed)	wind tunnel test			SS carbon fibre/foam
		PT1000 sensors (to be glued on heater surface)		.01_P5 requires:	J	
			•	air-cooling mechanism verification Possible preliminary FPC (mechanical) prototype to check volumes, transport etc) transport issues to wind tunnel facility		

Prototype	Components	Goal	Date	
IBL012_P6/7	 2+2+4 ER2 pad wafer L0+L1+L2 sensors (x 2 HB?) L0+L1+L2 local support structures gloabal support mechanics (advanced design) FPCs (advanced design) air distribution inlet & outlet (advanced design) 	 first complete IB HB prototype w/o sensors including test of wirebonding to FPCs final test on HB support mechanics possibly built 2 complete HBs (to allow HB mechanical support matching test) 	2026/07	→ L0/L1 pad sensors SS carbon fibre/foam
IBL012_P8	 2+2+4 ER2 wafer L0+L1+L2 sensors L0+L1+L2 local support structures mechanics, FPCs, cooling (~final/advanced design) 	 complete IB HB prototype w/ sensors qualification model w/ bent sensors for cooling + powering/DAQ/DCS finalisation 	2026/10	L0/L1 ER2 sensors SS carbon fibre/foam

Prototyping campaign vs Material procurement



Silicon sensors:

Silicon pieces	4 L0 - 4 L1	AVAILABLE No spares	
Heaters	2 L0 - 2 L1	Under production at CERN (Rui team) Foreseen: 4 L0 - 4 L1	
Pad sensors	[2 L0 - 2 L1 - (4 L2)] x 2	If two half-barrels (16 pad sensors = 16 wafers) → no spares	
ER2 sensors	2 L0 - 2 L1 - (4 L2)	Only one half-barrel No spares	

Support structures:

3D printed	Many	Actually mixing printed and manufactured in very first exercises
Carbon fibre/foam	Many	Design and material to be established (foam for half-rings and fibre for logerons) Foam procurement and shaping: - Genova INFN → To be explored - Berkley (Nikki) → Expressed availability - U.K. (George) → Expressed availability Carbon fibre production: - producer to be identified